EcoSPARK® 2 Ignition IGBT

300 mJ, 400 V, N-Channel Ignition IGBT

Features

- SCIS Energy = 300 mJ at $T_J = 25$ °C
- Logic Level Gate Drive
- AEC-Q101 Qualified and PPAP Capable
- RoHS Compliant

Applications

- Automotive Ignition Coil Driver Circuits
- Coil on Plug Application

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

| Symbol | Parameter | Value | Units |
|----------------------|---|------------|-------|
| BV _{CER} | Collector to Emitter Breakdown Voltage (I _C = 1 mA) | 400 | V |
| BV _{ECS} | Emitter to Collector Voltage – Reverse Battery Condition (I _C = 10 mA) | 28 | V |
| E _{SCIS25} | Self Clamping Inductive Switching Energy (Note 1) | 300 | mJ |
| E _{SCIS150} | Self Clamping Inductive Switching Energy (Note 2) | 170 | mJ |
| I _{C25} | Collector Current Continuous at VGE = 5.0 V, T _C = 25°C | 41 | Α |
| I _{C110} | Collector Current Continuous at VGE = 5.0 V, T _C = 110°C | 25.6 | Α |
| V _{GEM} | Gate to Emitter Voltage Continuous | ±10 | V |
| P _D | Power Dissipation Total, T _C = 25°C | 150 | W |
| | Power Dissipation Derating, T _C > 25°C | 1 | W/°C |
| TJ | Operating Junction and Storage Temperature | -55 to 175 | °C |
| T _{STG} | Storage Junction Temperature Range | -55 to 175 | °C |
| TL | Max. Lead Temperature for Soldering (Package Body for 10 s) | 300 | °C |
| T _{PKG} | Max. Lead Temperature for Soldering (Package Body for 10 s) | 260 | °C |
| ESD | HBM – Electrostatic Discharge Voltage at 100 pF, 1500 Ω | 4 | kV |
| | CDM – Electrostatic Discharge Voltage at 1 Ω | 2 | kV |

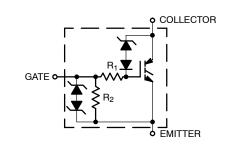
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Self clamped inductive Switching Energy (ESCIS25) of 300 mJ is based on the test conditions that is starting T_J = 25°C, L = 3 mHy, ISCIS = 14.2 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.
- Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting T_J = 150°C, L = 3mHy, ISCIS = 10.8 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.



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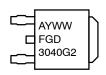
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DPAK (SINGLE GAUGE) CASE 369C

MARKING DIAGRAM



A = Assembly Location Y = Year WW = Work Week

FGD3040G2= Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

| Characteristic | Symbol | Max | Units |
|---|----------------|-----|-------|
| Junction-to-Case - Steady State (Drain) | $R_{	heta JC}$ | 1 | °C/W |

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

| Symbol | Parameter | Test C | Conditions | Min | Тур. | Max. | Units |
|----------------------|---|---|-------------------------------|------|------|------|-------|
| FF CHARA | ACTERISTICS | | | | | | |
| BV _{CER} | Collector to Emitter Breakdown Voltage | $I_{CE} = 2 \text{ mA}, V_{GE} = 0 \text{ V}, \\ R_{GE} = 1 \text{ k}\Omega, T_{J} = -40 \text{ to } 150^{\circ}\text{C}$ | | 370 | 400 | 430 | V |
| BV _{CES} | Collector to Emitter Breakdown Voltage | I _{CE} = 10 mA, V _{GE} = 0 V, R _{GE} = 0, T _J = -40 to 150°C | | 390 | 420 | 450 | ٧ |
| BV _{ECS} | Emitter to Collector Breakdown Voltage | $I_{CE} = -20 \text{ mA}, V_{GE} = 0 \text{ V},$ $T_{J} = 25^{\circ}\text{C}$ | | 28 | - | - | ٧ |
| BV _{GES} | Gate to Emitter Breakdown Voltage | I _{GES} = ±2 mA | | ±12 | ±14 | - | V |
| I _{CER} | Collector to Emitter Leakage Current | V _{CE} = 250 V | T _J = 25°C | - | - | 25 | μΑ |
| | | $R_{GE} = 1 k\Omega$ | T _J = 150°C | - | - | 1 | mA |
| I _{ECS} | Emitter to Collector Leakage Current | V _{EC} = 24 V | T _J = 25°C | - | _ | 1 | mA |
| | | | T _J = 150°C | - | _ | 40 | |
| R ₁ | Series Gate Resistance | | • | - | 120 | - | Ω |
| R ₂ | Gate to Emitter Resistance | | | 10K | _ | 30K | Ω |
| N CHARA | CTERISTICS (Note 5) | | | | | | |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | I _{CE} = 6 A, V _{GE} = 4 V, T _J = 25°C | | - | 1.15 | 1.25 | V |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | I _{CE} = 10 A, V _{GE} = 4.5 V, T _J = 150°C | | - | 1.35 | 1.50 | V |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | I _{CE} = 15 A, V _{GE} = 4.5 V, T _J = 150°C | | - | 1.68 | 1.85 | V |
| E _{SCIS} | Self Clamped Inductive Switching | L = 3.0 mHy, RG = 1 K Ω , VGE = 5 V, (Note 1) | | - | - | 300 | mJ |
| YNAMIC C | HARACTERISTICS | • | | | | • | • |
| Q _{G(ON)} | Gate Charge | I _{CE} = 10 A, V _{CE} | = 12 V, V _{GE} = 5 V | - | 21 | - | nC |
| V _{GE(TH)} | Gate to Emitter Threshold Voltage | $I_{CE} = 1 \text{ mA}$ $V_{CE} = V_{GE}$ | T _J = 25°C | 1.3 | 1.7 | 2.2 | V |
| . , | | | T _J = 150°C | 0.75 | 1.2 | 1.8 | |
| V_{GEP} | Gate to Emitter Plateau Voltage | V _{CE} = 12 V, I _{CE} | = 10 A | - | 2.8 | - | V |
| WITCHING | CHARACTERISTICS | | | | | | |
| td _{(ON)R} | Current Turn-On Delay Time-Resistive | $V_{CE} = 14 \text{ V}, R_L = 1 \Omega, V_{GE} = 5 \text{ V},$ $R_G = 1 \text{ K}\Omega, T_J = 25^{\circ}\text{C}$ | | - | 0.9 | 4 | μs |
| t _{rR} | Current Rise Time-Resistive | | | - | 1.9 | 7 | 1 |
| td _{(OFF)L} | Current Turn-Off Delay Time-Inductive | V_{CE} = 300 V, L = 1 mH, V_{GE} = 5 V, P_{G} = 1 K Ω , I_{CE} = 6.5 A, P_{J} = 25°C | | - | 4.8 | 15 | 1 |
| t _{fl} | Current Fall Time-Inductive | | | _ | 2.0 | 15 | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND DEVICE ORDERING INFORMATION

| D | evice Marking | Device | Package | Reel Diameter | Tape Width | Qty [†] |
|----|---------------|-----------------|----------------|---------------|------------|------------------|
| FG | D3040G2 | FGD3040G2-F085V | DPAK (Pb-Free) | 330 mm | 16 mm | 2500 |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

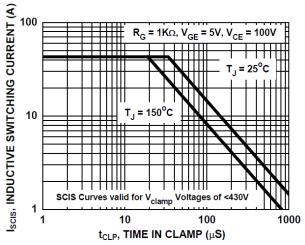


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp

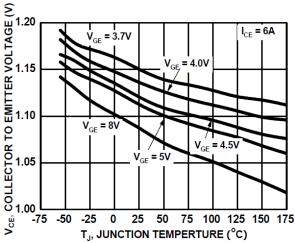


Figure 3. Collector to Emitter On-State Voltage vs. Junction Temperature

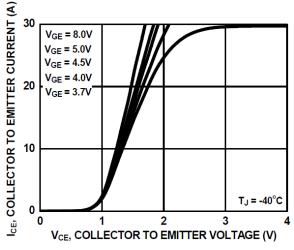


Figure 5. Collector to Emitter On-State Voltage vs. Collector Current

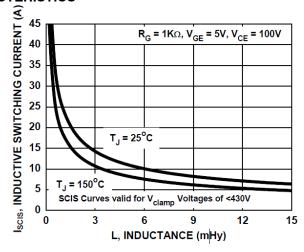


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

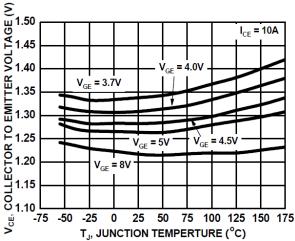


Figure 4. Collector to Emitter On-State Voltage vs. Junction Temperature

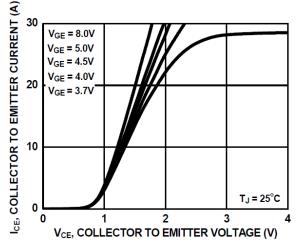


Figure 6. Collector to Emitter On-State Voltage vs. Collector Current

TYPICAL CHARACTERISTICS (continued)

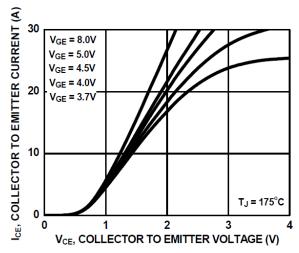


Figure 7. Collector to Emitter On-State Voltage vs.
Collector Current

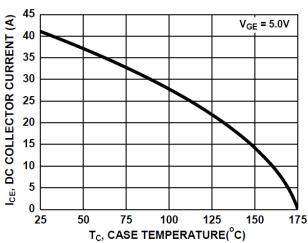


Figure 9. DC Collector Current vs. Case Temperature

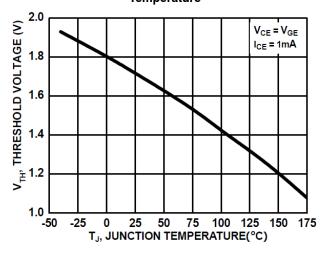


Figure 11. Threshold Voltage vs. Junction Temperature

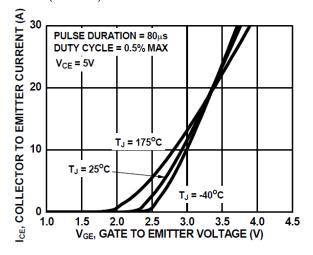


Figure 8. Transfer Characteristics

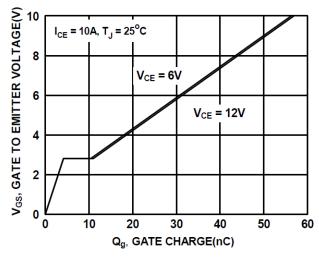


Figure 10. Gate Charge

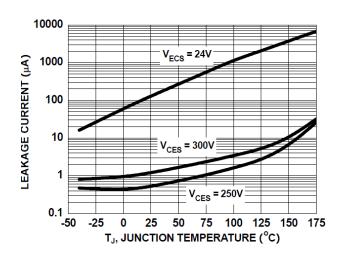
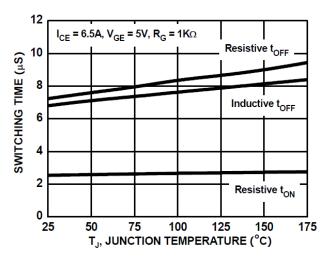


Figure 12. Leakage Current vs. Junction Temperature

TYPICAL CHARACTERISTICS (continued)



2000 f = 1MHz $V_{GE} = 0V$ 1600 CAPACITANCE (pF) CIES 1200 800 C_{RES} 400 COES 0 5 25 10 15 20 V_{DS}, DRAIN TO SOURCE VOLTAGE (V)

Figure 13. Switching Time vs. Junction Temperature

Figure 14. Capacitance vs. Collector to Emitter Voltage

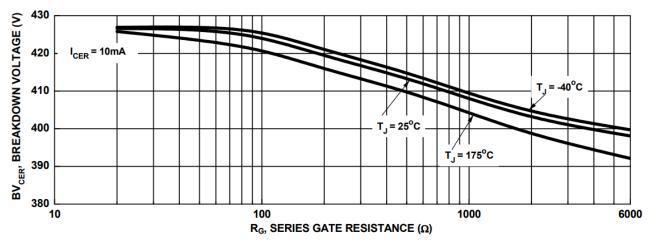


Figure 15. Break down Voltage vs. Series Resistance

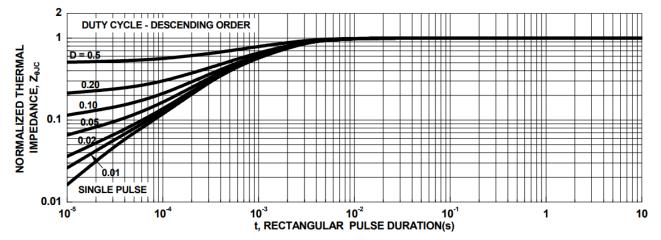


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

TYPICAL CHARACTERISTICS (continued)

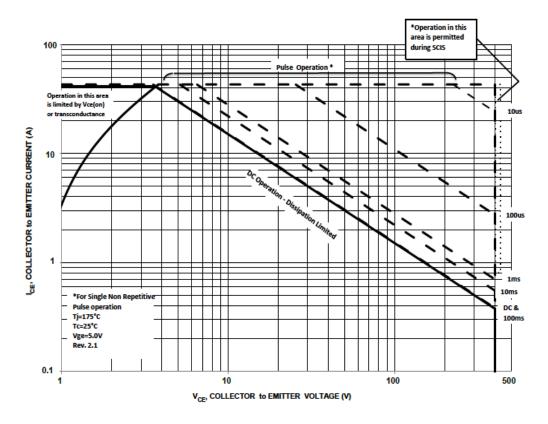


Figure 17. Forward Safe Operating Area

TEST CIRCUIT AND WAVEFORMS

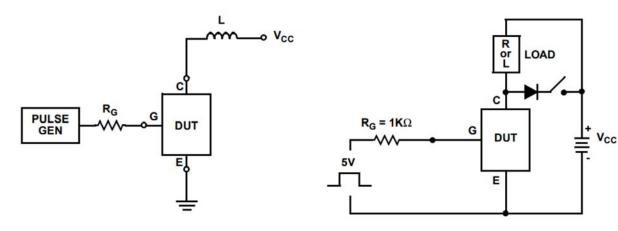


Figure 18. Inductive Switching Test Circuit

Figure 19. $t_{\mbox{\scriptsize ON}}$ and $t_{\mbox{\scriptsize OFF}}$ Switching Test Circuit

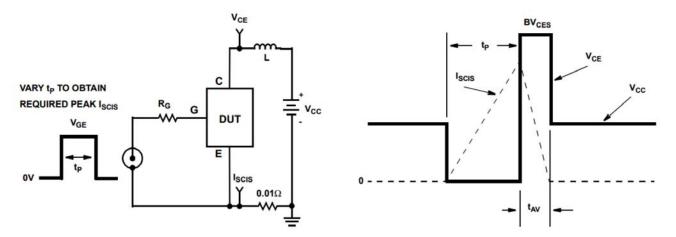
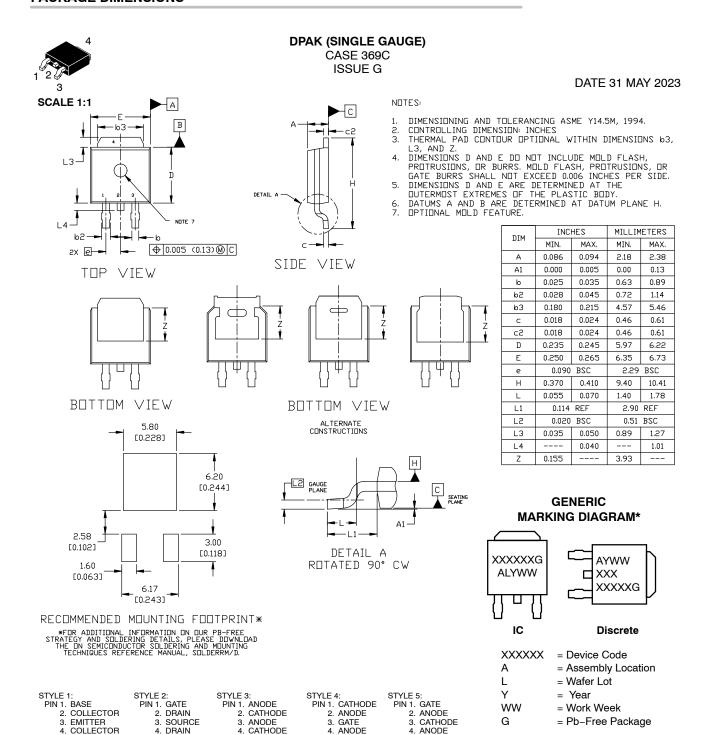


Figure 20. Energy Test Circuit

Figure 21. Energy Waveforms

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|------------------------------|---------------------|---|-------------|--|
| DESCRIPTION: | DPAK (SINGLE GAUGE) | | PAGE 1 OF 1 | |

STYLE 10:

PIN 1. CATHODE 2. ANODE

3 CATHODE

4. ANODE

STYLE 9:

PIN 1. ANODE 2. CATHODE

3 RESISTOR ADJUST

CATHODE

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STYLE 7: PIN 1. GATE 2. COLLECTOR

3 FMITTER

4. COLLECTOR

STYLE 8:

PIN 1. N/C 2. CATHODE

3 ANODE

CATHODE

STYLE 6:

PIN 1. MT1 2. MT2

3 GATE

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot "=", may

or may not be present. Some products may

not follow the Generic Marking.

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